

## NC7WZ08 TinyLogic® UHS Dual 2-Input AND Gate

### General Description

The NC7WZ08 is a dual 2-Input AND Gate from Fairchild's Ultra High Speed Series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65V to 5.5V  $V_{CC}$  range. The inputs and output are high impedance when  $V_{CC}$  is 0V. Inputs tolerate voltages up to 7V independent of  $V_{CC}$  operating voltage.

### Features

- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Ultra High Speed;  $t_{PD}$  2.5 ns Typ into 50 pF at 5V  $V_{CC}$
- High Output Drive;  $\pm 24$  mA at 3V  $V_{CC}$
- Broad  $V_{CC}$  Operating Range; 1.65V to 5.5V
- Matches the performance of LCX when operated at 3.3V  $V_{CC}$
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

### Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7WZ08K8X	MAB08A	WZ08	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7WZ08K8X_NL (Note 1)	MAB08A	WZ08	Pb-Free 8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7WZ08L8X	MAC08A	N4	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

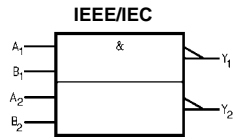
Pb-Free package per JEDEC J-STD-020B.

**Note 1:** "\_NL" indicates lead-free product (per JEDEC J-STD-020B). Device is available in Tape and Reel only.

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NC7WZ08 TinyLogic® UHS Dual 2-Input AND Gate

**Logic Symbol**



**Pin Descriptions**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
Y <sub>n</sub>	Output

**Function Table**

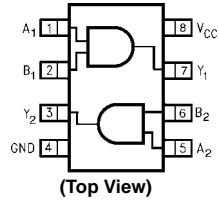
$Y = AB$

Inputs		Output
A	B	Y
L	L	L
L	H	L
H	L	L
H	H	H

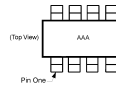
H = HIGH Logic Level

L = LOW Logic Level

**Connection Diagrams**



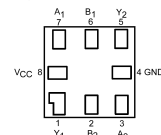
**Pin One Orientation Diagram**



AAA represents Product Code Top Mark - see ordering code

**Note:** Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

**Pad Assignments for MicroPak**



**(Top Thru View)**

### Absolute Maximum Ratings (Note 2)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7V
DC Input Voltage ( $V_{IN}$ )	-0.5V to +7V
DC Output Voltage ( $V_{OUT}$ )	-0.5V to +7V
DC Input Diode Current ( $I_{IK}$ )	
@ $V_{IN} < -0.5V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
@ $V_{OUT} < -0.5V$	-50 mA
DC Output Current ( $I_{OUT}$ )	±50 mA
DC $V_{CC}/GND$ Current ( $I_{CC}/I_{GND}$ )	±100 mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Junction Temperature under Bias ( $T_J$ )	150°C
Junction Lead Temperature ( $T_L$ )	
(Soldering, 10 seconds)	260°C
Power Dissipation ( $P_D$ ) @ +85°C	250 mW

### Recommended Operating Conditions (Note 3)

Supply Voltage Operating ( $V_{CC}$ )	1.65V to 5.5V
Supply Voltage Data Retention ( $V_{CC}$ )	1.5V to 5.5V
Input Voltage ( $V_{IN}$ )	0V to 5.5V
Output Voltage ( $V_{OUT}$ )	0V to $V_{CC}$
Operating Temperature ( $T_A$ )	-40°C to +85°C
Input Rise and Fall Time ( $t_r, t_f$ )	
$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$	0 ns/V to 20 ns/V
$V_{CC} = 3.3V \pm 0.3V$	0 ns/V to 10 ns/V
$V_{CC} = 5.0V \pm 0.5V$	0 ns/V to 5 ns/V
Thermal Resistance ( $\theta_{JA}$ )	250°C/W

**Note 2:** Absolute maximum ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

**Note 3:** Unused inputs must be held HIGH or LOW. They may not float.

### DC Electrical Characteristics

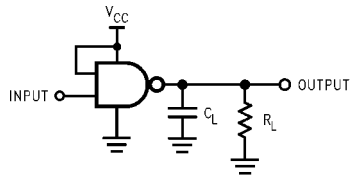
Symbol	Parameter	$V_{CC}$ (V)	$T_A = 25^\circ C$			$T_A = -40^\circ C \text{ to } +85^\circ C$		Units	Conditions	
			Min	Typ	Max	Min	Max			
$V_{IH}$	HIGH Level Input Voltage	1.65-1.95 2.3-5.5	0.75 $V_{CC}$ 0.7 $V_{CC}$			0.75 $V_{CC}$ 0.7 $V_{CC}$		V		
$V_{IL}$	LOW Level Input Voltage	1.65-1.95 2.3-5.5	0.25 $V_{CC}$ 0.3 $V_{CC}$			0.25 $V_{CC}$ 0.3 $V_{CC}$		V		
$V_{OH}$	HIGH Level Output Voltage	1.65	1.55	1.65	1.55		V	$V_{IN} = V_{IH}$	$I_{OH} = -100 \mu A$	
		2.3	2.2	2.3	2.2					
		3.0	2.9	3.0	2.9		V		$I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$ $I_{OH} = -16 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -32 \text{ mA}$	
		4.5	4.4	4.5	4.4					
		1.65	1.29	1.52	1.29		V			
		2.3	1.9	2.15	1.9					
		3.0	2.5	2.80	2.4		V			
		3.0	2.4	2.68	2.3					
		4.5	3.9	4.20	3.8		V			
$V_{OL}$	LOW Level Output Voltage	1.65	0.0			0.1		V	$V_{IN} = V_{IL}$	$I_{OL} = 100 \mu A$
		2.3	0.0			0.1				
		3.0	0.0			0.1		V		
		4.5	0.0			0.1				
		1.65	0.08			0.24		V		$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$ $I_{OL} = 16 \text{ mA}$ $I_{OL} = 24 \text{ mA}$ $I_{OL} = 32 \text{ mA}$
		2.3	0.10			0.3				
		3.0	0.15			0.4		V		
		3.0	0.22			0.55				
		4.5	0.22			0.55		V		
$I_{IN}$	Input Leakage Current	0-5.5	±0.1			±1		μA	$V_{IN} = 5.5V, GND$	
$I_{OFF}$	Power Off Leakage Current	0.0	1			10		μA	$V_{IN}$ or $V_{OUT} = 5.5V$	
$I_{CC}$	Quiescent Supply Current	1.65-5.5	1			10		μA	$V_{IN} = 5.5V, GND$	

## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	1.8 ± 0.15	2.0	5.7	10.5	2.0	11.0	ns	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 1 MΩ	Figures 1, 3
		2.5 ± 0.2	1.0	3.5	5.8	1.0	6.2			
		3.3 ± 0.3	0.8	2.6	3.9	0.8	4.3			
		5.0 ± 0.5	0.5	1.9	3.1	0.5	3.3			
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	3.3 ± 0.3	1.2	3.2	4.8	1.2	5.2	ns	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω	Figures 1, 3
		5.0 ± 0.5	0.8	2.5	3.7	0.8	4.0			
C <sub>IN</sub>	Input Capacitance	0	2.5					pF		
C <sub>PD</sub>	Power Dissipation Capacitance	3.3	14.5					pF	(Note 4)	Figure 2
		5.0	19.5							

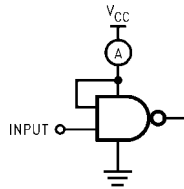
**Note 4:** CPD is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  
 $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC} \text{ static})$

## AC Loading and Waveforms



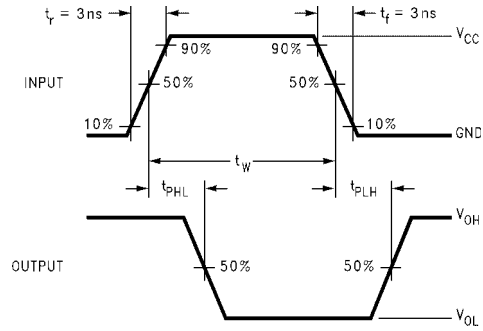
C<sub>L</sub> includes load and stray capacitance  
 Input PRR = 1.0 MHz, t<sub>w</sub> = 500 ns

**FIGURE 1. AC Test Circuit**



Input = Ac Waveform; t<sub>r</sub> = t<sub>f</sub> = 1.8 ns;  
 PRR = 10 MHz; Duty Cycle = 50%

**FIGURE 2. I<sub>CCD</sub> Test Circuit**

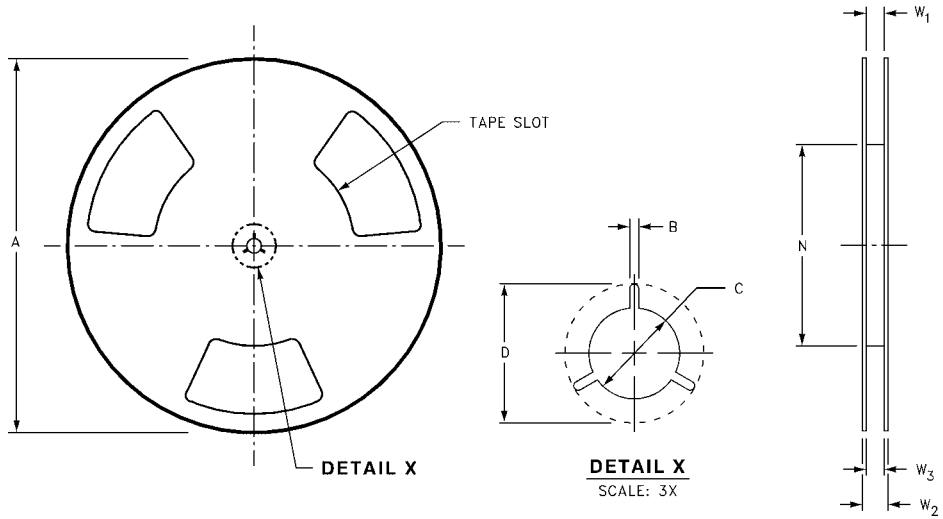


**FIGURE 3. AC Waveforms**



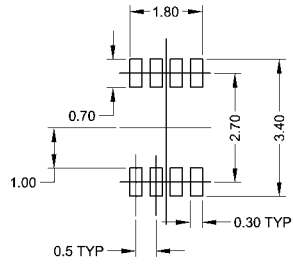
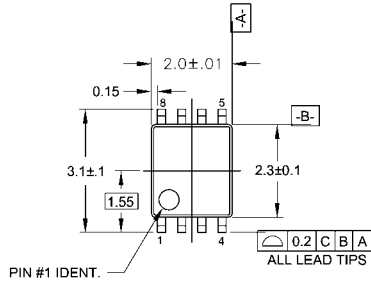
**Tape and Reel Specification** (Continued)

REEL DIMENSIONS inches (millimeters)

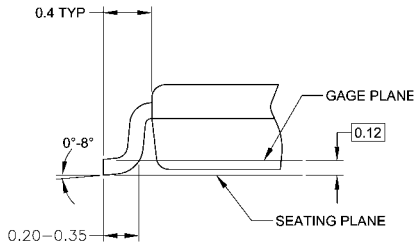
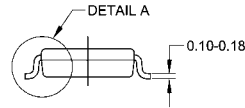
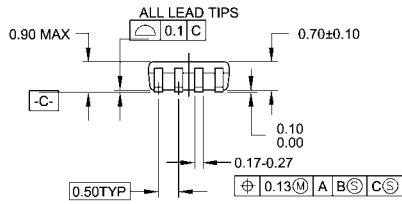


Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	$0.331 + 0.059/-0.000$ ( $8.40 + 1.50/-0.00$ )	0.567 (14.40)	$W1 + 0.078/-0.039$ ( $W1 + 2.00/-1.00$ )

**Physical Dimensions** inches (millimeters) unless otherwise noted



**LAND PATTERN RECOMMENDATION**



**DETAIL A**

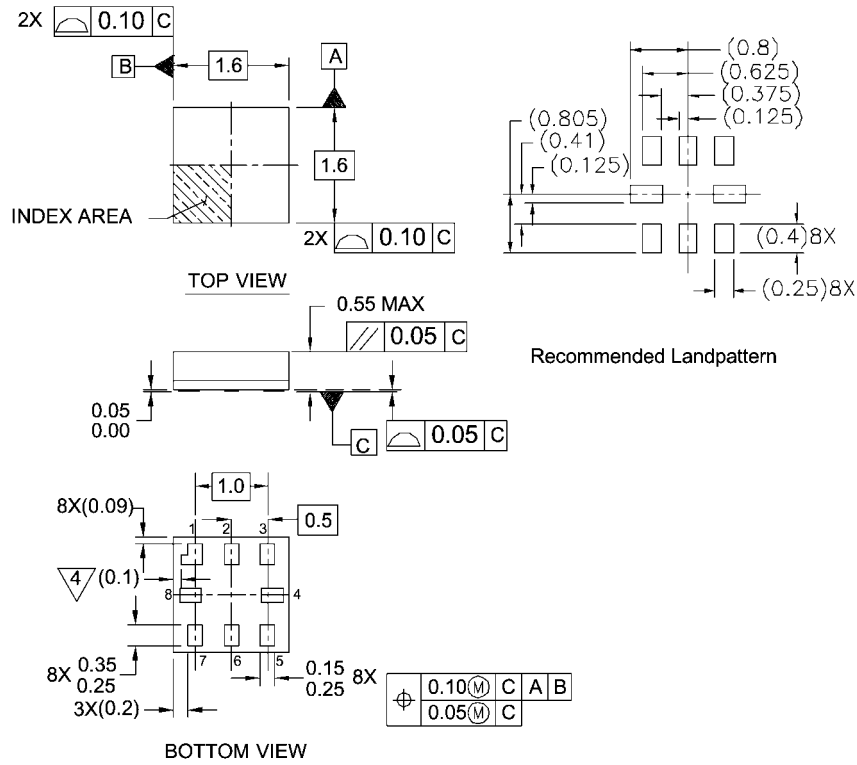
**NOTES:**

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

**8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide  
Package Number MAB08A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



- Notes:
1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
  2. DIMENSIONS ARE IN MILLIMETERS
  3. DRAWING CONFORMS TO ASME Y.14M-1994
  - 4/PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

**Pb-Free 8-Lead MicroPak, 1.6 mm Wide  
Package Number MAC08A**

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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